RFPO40



Specifications

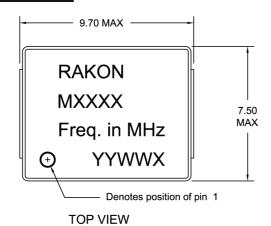
1.0	SPECIFICATION REFERENCES					
Line	Parameter					
1.1	Description / Part Number	10.0MHz RFPO41-VX-A-LF (10.0MHz MERC 9x7 HOT CMOS 3.3V Pu 02-03)	ll) / M5767LF, i	ss. 1 (2012-		
1.2	RoHS compliant	Yes				
1.3	Package size	9.7 mm x 7.5 mm x 4.3 mm				
	-					
2.0	FREQUENCY CHARACTE					
Line	Parameter	Test Condition	Value	Unit		
2.1	Nominal Frequency		10.0	MHz		
2.2	Frequency calibration	At 25°C±2°C, Vc=1.5V, at time of shipment, reference to nominal frequency (note 1)	±0.5 max	ppm		
2.3	Reflow shift	After 1 hour recovery at 25°C	±1 max	ppm		
2.4	Frequency stability over temperature in still air	Reference to (Fmax+Fmin)/2 (note 1)	±20 max	ppb		
2.5	Temperature range	The operating temperature range over which the frequency stability is measured	-40 to 85	°C		
2.6	Frequency slope in still air	Temperature ramp 1°C/minute	±2 max	ppb/°C		
2.7	Supply voltage stability	±5% variation, reference to frequency at 3.3V, typical	±10	ppb		
2.8	Load sensitivity	±5pF variation, reference to frequency at 15pF, typical	±10	ppb		
2.9	Warm-up time	Note 2, typically less than	3	minutes		
2.10	g-sensitivity	Gamma vector of all three axes from 30 Hz to 1500 Hz, typically less than	2	ppb/g		
3.0	FREQUENCY AGING (nominal frequency ≤26 MHz)					
Line	Parameter	Test Condition	Value	Unit		
3.1	Long term stability	Per day (note 3), typically less than	±2	ppb		
3.2	Long term stability	First year	±1 max	ppm		
3.3	Long term stability	10 years	±3 max	ppm		
		_				
4.0	ROOT ALLAN VARIANCE		\			
Line	Parameter	Test Condition	Value	Unit		
4.1	Root Allan Variance	Typical value at 25°C, tau = 0.1s	7	E-11		
4.2	Root Allan Variance	Typical value at 25°C, tau = 1.0s	7	E-11		
4.3	Root Allan Variance	Typical value at 25°C, tau = 10s	7	E-11		
4.4	Root Allan Variance	Typical value at 25°C, tau = 100s	8	E-11		
4.5	Root Allan Variance	Typical value at 25°C, tau = 1000s	18	E-11		
5.0	POWER SUPPLY					
Line	Parameter	Test Condition	Value	Unit		
5.1	Supply voltage	±5%	3.3	V		
5.2	Input power	warm up, typical	1000	mW		
5.3	Input Power	Steady state in still air at 25°C	400 max	mW		

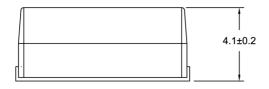
6.0	CONTROL VOLTAGE (VCO) - OPTION					
Line	Parameter	Test Condition	Value	Unit		
6.1	Control voltage, Vc	pin 1: Vc (note 4)	0.5 to 2.5	V		
6.2	Frequency tuning range	Over control voltage range (reference to frequency at $Vc=1.5 V$)	±5 min	ppm		
6.3	Frequency tuning linearity	Deviation from linear over control voltage range in accordance with MIL-PRF-55310	1 max	%		
6.4	Slope	Positive				
6.5	Port input impedance		80 min	kΩ		
6.6	Modulation bandwidth	Typical value	3.5	kHz		
7.0	HCMOS OSCILLATOR OUTPUT					
Line	Parameter	Test Condition	Value	Unit		
7.1	Output waveform	HCMOS				
7.2	Output voltage level low	Measured with a capacitive load of 15pF	10 max	%Vcc		
7.3	Output voltage level high	Measured with a capacitive load of 15pF	90 min	%Vcc		
7.4	Rise and fall times	Measured with a capacitive load of 15pF	4 max	ns		
7.5	Duty cycle	Measured at 50% level	45 to 55	%		
7.6	Output load	Nominal	15	pF		
8.0	SSB PHASE NOISE					
Line	Parameter	Test Condition	Value	Unit		
8.1	SSB phase noise power density at 1 Hz offset	Typical value at 25°C	-72	dBc/Hz		
8.2	SSB phase noise power density at 10 Hz offset	Typical value at 25°C	-98	dBc/Hz		
8.3	SSB phase noise power density at 100 Hz offset	Typical value at 25°C	-123	dBc/Hz		
8.4	SSB phase noise power density at 1kHz offset	Typical value at 25°C	-142	dBc/Hz		
8.5	SSB phase noise power density at 10kHz offset	Typical value at 25°C	-149	dBc/Hz		
8.6	SSB phase noise power density at 100kHz offset	Typical value at 25°C	-150	dBc/Hz		
8.7	SSB phase noise power density at 1MHz offset	Typical value at 25°C	-150	dBc/Hz		

9.0	ENVIRONMENTAL			
Line	Parameter	Test Condition	Value	Unit
9.1	Storage temperature		-55 to 125	°C
9.2	Acceleration steady state	IEC 60068-2-7 test Ga, 5000g, 10s (at peak acceleration), Y-axis only		
9.3	Moisture sensitivity	IPC/JEDEC J-STD-020, Class 1		
9.4	Temperature cycling	IEC 60068-2-14 test Na, 400 cycles, -40°C to +125°C		
9.5	Solder ability	JESD 22-B102D, Method 2 Preconditioning 150°C, 16 hours		
9.6	Humidity	EIA/JEDEC22-A101, 85°C/85%R.H., 1000 hours		
9.7	Shock	IEC 60068-2-27, test Ea; 1500g, 0.5ms, 18 shocks total		
9.8	Vibration	IEC 60068-2-6, test Fc: 20g, 60 to 2000Hz 12 hours total		
9.9	RoHS	Parts are fully compliant with the European Union directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment. Note parts are suitable for assembly using both Lead-free solders and Tin/Lead solders		
10.0	PIN CONNECTIONS			
Line	Parameter	Description		
10.1	Pin 1: Control Voltage, Vc	Note 4		
10.2	Pin 2: GND			
10.3	Pin 3: OUTPUT			
10.4	Pin 4: Vcc	For correct operation decouple the supply voltage with a 10 μF capa	citor close to the	e oscillator
11.0	MARKING			
Line	Parameter	Description		
11.1	Туре	Laser marked		
11.2	Line 1	RAKON		
11.3	Line 2	Part number (Mxxxx)		
11.4	Line 3	Frequency in MHz (xx.x MHz)		
11.5	Line 4	Pin 1 identifier (dot), and date / location code (YYWWX)		
12.0	MANUFACTURING INFOR	RMATION		
Line	Parameter	Description		
12.1	Reflow	IPC/JEDEC J-STD-020, Package reflow temperature for the Pb-Free the Sn-Pb eutectic process is 220°C. The solder reflow processes are profiles	•	,
12.2	Packaging description	Tape and reel. 24mm wide tape and Ø330mm (Ø13") reel. Standard 1000 units per reel	l packing quanti	ty is 100 to
13.0	SPECIFICATION NOTES			
Line	Parameter	Description		
13.1	Note 1	The characteristics of the component may be temporarily affected be assembly and soldering. The frequency specifications apply 48 hour conditions apply unless otherwise stated		
13.2	Note 2	Time needed for frequency to be within ±20 ppb reference to freque Parameter is frequency, assembly and operating history dependent	ncy after 1 hour	r, at 25°C.
13.3	Note 3	After 30 days of continuous operation		
13.4	Note 4	The GND of the control voltage needs to be connected directly to pin impedance may cause performance degradation	n 2 as ground le	ad

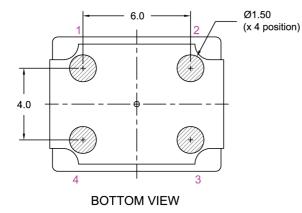
Drawing Name: RFPO40/45 Model Drawing

MODEL DRAWING





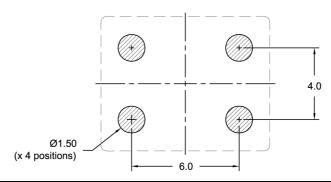
FRONT VIEW



NOTE:

- 1. Pin connections are detailed in the specification.
- 2. Cover: Plastic
- 3. Base: FR4
- 4. Finish: $0.05 \sim 0.13~\mu m$ Gold over $3 \sim 6~\mu m$ Nickel

RECOMMENDED PAD LAYOUT - TOP VIEW



TITLE: RFPO40/45 MODEL DRAWING

RELATED DRAWINGS:

 REVISION:
 C
 TOLERANCES:

 DATE:
 25-Jan-12
 X.X
 = ±0.2

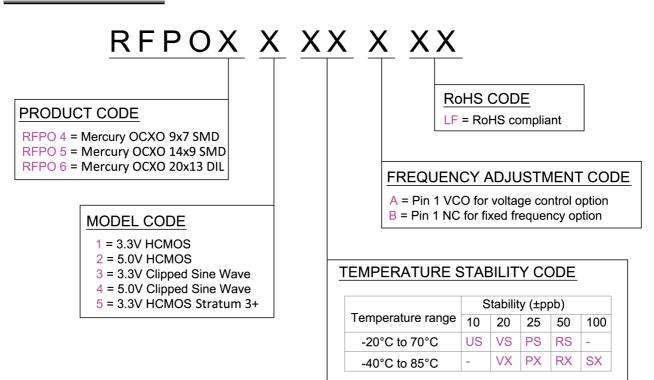
 SCALE:
 5:1
 X.XXX
 = ±0.10

 Millimetres
 X°
 =

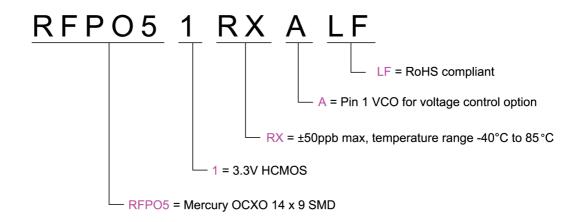


Drawing Name: Mercury-RFPO Model Code

MODEL CODE BUILDER:



EXAMPLE:



TITLE: MERCURY-RFPO MODEL CODE BUILDER FILENAME: CAT645

RELATED DRAWINGS:

REVISION: A

DATE: 12-Oct-11

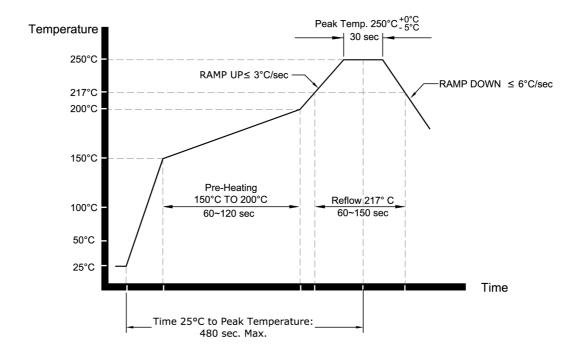
SCALE: NTS

Millimetres

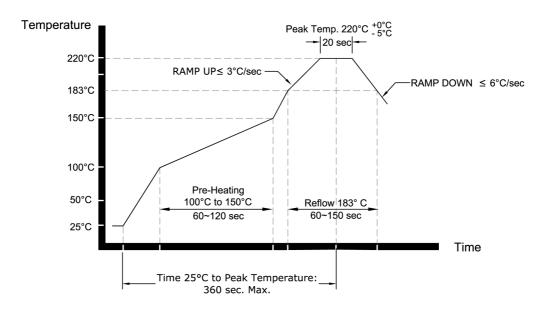


Drawing Name: RFPO40 Series Reflow

Pb-Free Reflow Soldering Profile *



Sn-Pb Eutectic Reflow Soldering Profile *



* NOTE:

These profile were used during the qualification testing of the product and therefore represents worst case conditions. It is not recommended for use by the customer in the actual assembly of these parts.

TITLE: RFPO40 SERIES REFLOW FILENAME: CAT649

RELATED DRAWINGS:

REVISION: A
DATE: 25-Oct-11
SCALE: NTS
Millimetres



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